N OR NS[†] PACKAGE (TOP VIEW)

1B

1A 2

1Y || 3

GΠ

2Y 🚺 5

2A

2B [] 7

GND

4

6

8

reeled (order device SN75ALS173 NSLE).

[†] The NS package is only available left-end taped and

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16 VCC

15 🛛 4B

14 4A

13 🛛 4Y

12 🛛 G

11 🛛 3Y

10 🛛 3A

9 🛛 3B

- Meets or Exceeds the Requirements of ANSI EIA/TIA-422-B, EIA/TIA-423-B, and RS-485
- Meets or Exceeds the Requirements of ITU Recommendations V.10, V.11, X.26, and X.27
- Designed for Multipoint Bus Transmission on Long Bus Lines in Noisy Environments
- 3-State Outputs
- Common-Mode Input Voltage Range of -12 V to 12 V
- Input Sensitivity ... ±200 mV
- Input Hysteresis . . . 50 mV Typ
- High Input Impedance . . . 12 k Ω Min
- Operates From Single 5-V Supply
- Low Supply-Current Requirement 27 mA Max

description

The SN75ALS173 is a monolithic quadruple differential line receiver with 3-state outputs. It is designed to meet the requirements of ANSI Standards EIA/TIA-422-B, EIA/TIA-423-B, RS-485, and several ITU recommendations. Advanced low-power Schottky technology provides high speed without the usual power penalty. The four receivers have an ORed pair of enables in common. Either G high or \overline{G} low enables all of the receivers. The device features high input impedance, input hysteresis for increased noise immunity, and input sensitivity of ± 200 mV over a common-mode input voltage range of -12 V to 12 V.

The SN75ALS173 is characterized for operation from 0°C to 70°C.

(each receiver)							
DIFFERENTIAL	ENA	-	OUTPUT				
A – B	G	G	Y				
	Н	Х	Н				
$V_{ID} \ge 0.2 V$	Х	L	Н				
– 0.2 V < V חוV < 0.2 V	н	Х	?				
-0.2 V < V[D < 0.2 V	Х	L	?				
	н	Х	L				
$V_{ID} \le -0.2 V$	Х	L	L				
Х	L	Н	Z				
Open Circuit	н	Х	Н				
	Х	L	Н				

FUNCTION TABLE

H = high level, L = low level, ? = indeterminate, X = irrelevant, Z = high impedance (off)



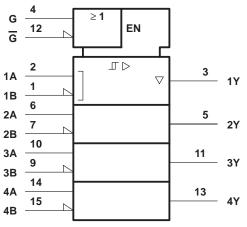
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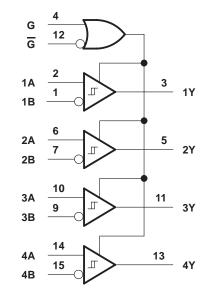
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logic symbol[†]

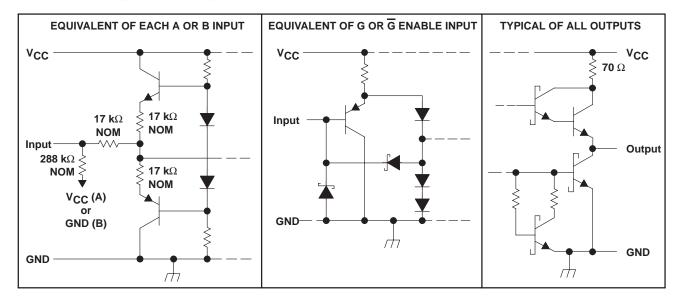


[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



schematics of inputs and outputs





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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V _{CC} (see Note 1) Input voltage, V _I (A or B inputs)	
Differential input voltage, VID (see Note 2)	
Enable input voltage, V _I	
Low-level output current, I _{OL}	50 mA
Continuous total dissipation	See Dissipation Rating Table
Operating free-air temperature range, T _A	0°C to 70°C
Storage temperature range, T _{stg}	–65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values, except differential input voltage, are with respect to network ground terminal.

2. Differential input voltage is measured at the noninverting input with respect to the corresponding inverting input.

DISSIPATION RATING TABLE								
PACKAGE	T _A ≤ 25°C POWER RATING	DERATING FACTOR ABOVE T _A = 25°C	T _A = 70°C POWER RATING					
N	1150 mW	9.2 mW/°C	736 mW					
NS	625 mW	5.0 mW/°C	400 mW					

recommended operating conditions

		MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}		4.75	5	5.25	V
Common-mode input voltage, VIC				±12	V
Differential input voltage, VID				±12	V
High-level input voltage, VIH	G, G	2			V
Low-level input voltage, VIL	G, G			0.8	V
High-level output current, IOH				-400	μA
Low-level output current, IOL				8	mA
Operating free-air temperature, T _A		0		70	°C

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electrical characteristics over recommended ranges of common-mode input voltage, supply voltage, and operating free-air temperature (unless otherwise noted) (see Note 3)

	PARAMETER	TE	TEST CONDITIONS			TYP [†]	MAX	UNIT	
V _{IT+}	Positive-going input threshold voltage						200	mV	
VIT-	Negative-going input threshold voltage					-200‡			mV
V _{hys}	Hysteresis voltage (V _{IT+} - V _{IT} _)						50		mV
VIK	Input clamp voltage	G, <u>G</u>	lı = – 18 mA					-1.5	V
Vон	OH High-level output voltage		V _{ID} = 200 mV,	$I_{OH} = -400 \ \mu A$,	See Figure 1	2.7			V
VOL	OL Low-level output voltage		$V_{ID} = -200 \text{ mV},$	I _{OL} = 8 mA,	See Figure 1			0.45	V
IOZ	Z High-impedance-state output current		$V_{O} = 0.4 V \text{ to } 2.4 V$				±20	μΑ	
1.			Other input at 0.1($V_{I} = 12 V$				1	mA	
1j	Line input current	_	Other input at 0 \	/	$V_{I} = -7 V$			-0.8	ША
Iн	High-level input current	G, <u>G</u>	VIH = 2.7 V					20	μΑ
IIL	Low-level input current	G, <u>G</u>	VIL = 0.4 V					-100	μΑ
ri	Input resistance				12			kΩ	
los	Short-circuit output current		See Note 4			-15		-85	mA
1			No load,	Outputs enabled			16	24	
ICC Supply current (total package)		No load,	Outputs disabled			18	27	mA	

[†] All typical values are at $V_{CC} = 5$ V and $T_A = 25^{\circ}C$.

[‡] The algebraic convention, in which the less positive (more negative) limit is designated as minimum, is used in this data sheet for threshold voltage levels only.

NOTES: 3. Refer to ANSI Standard RS-485 for exact conditions.

4. The duration of the short circuit should not cause the maximum package power dissipation to be exceeded.

switching characteristics, V_{CC} = 5 V, C_L = 15 pF, T_A = 25°C

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
^t PHL	Propagation delay time, high- to low-level output	$V_{ID} = -2.5 \text{ V to } 2.5 \text{ V},$	9	18	27	ns
tPLH	Propagation delay time, low- to high-level output	See Figure 2	9	18	27	ns
^t PZH	Output enable time to high level	See Figure 3	4	12	18	ns
tPZL	Output enable time to low level	See Figure 4	6	13	21	ns
^t PHZ	Output disable time from high level	See Figure 3	10	21	27	ns
t _{PLZ}	Output disable time from low level	See Figure 4	8	15	25	ns

PARAMETER MEASUREMENT INFORMATION

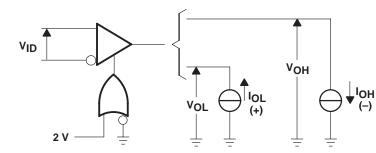
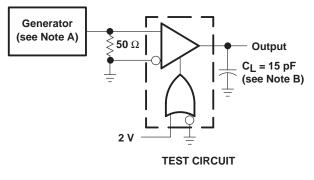


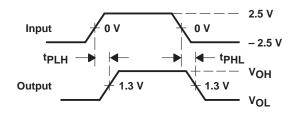
Figure 1. V_{OH}, V_{OL}



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PARAMETER MEASUREMENT INFORMATION





VOLTAGE WAVEFORMS

Figure 2. Test Circuit and Voltage Waveforms

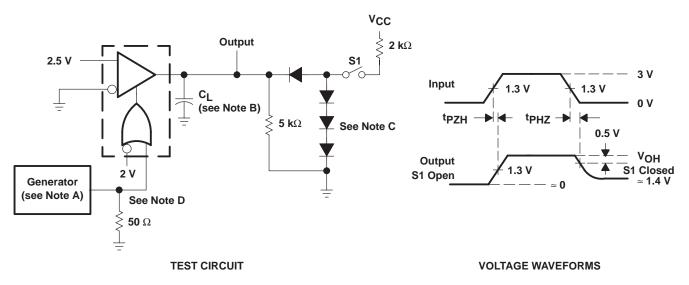
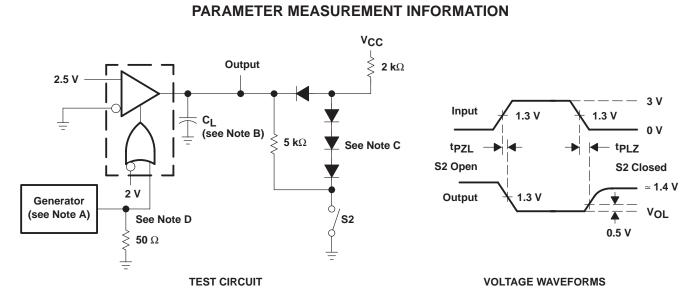


Figure 3. Test Circuit and Voltage Waveforms

- NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR = 1 MHz, duty cycle = 50%, $t_f \le 6$ ns, $t_f \le 6$ ns, $Z_O = 50 \Omega$.
 - B. CL includes probe and jig capacitance.
 - C. All diodes are 1N916 or equivalent.
 - D. To test the active-low enable \overline{G} , ground G and apply an inverted input waveform to \overline{G} .



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- NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR = 1 MHz, duty cycle = 50%, $t_{f} \le 6$ ns, $t_{f} \le 6$ ns, $Z_{O} = 50 \Omega$.
 - B. C_L includes probe and jig capacitance.
 - C. All diodes are 1N916 or equivalent.
 - D. To test the active-low enable \overline{G} , ground G and apply an inverted input waveform to \overline{G} .

Figure 4. Test Circuit and Voltage Waveforms

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PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN75ALS173N	ACTIVE	PDIP	Ν	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN75ALS173NSLE	OBSOLETE	SO	NS	16		None	Call TI	Call TI
SN75ALS173NSR	ACTIVE	SO	NS	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

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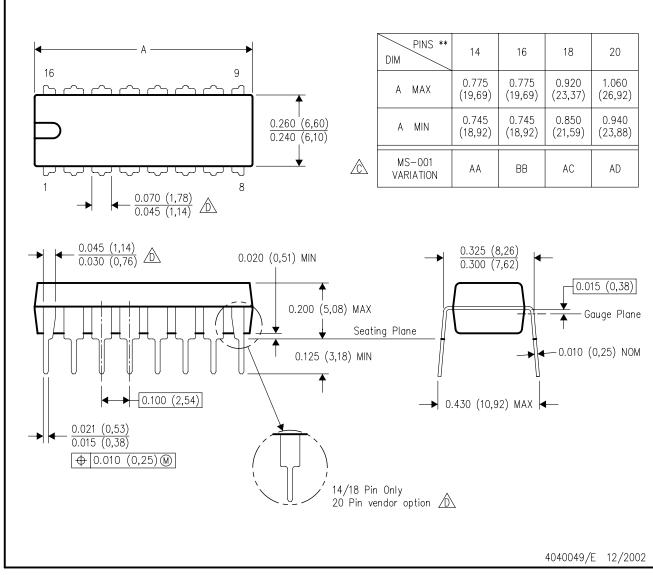
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N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.

A Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).

 \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



MECHANICAL DATA

PLASTIC SMALL-OUTLINE PACKAGE

0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 \bigcirc Gage Plane **L** 0,25 7 1 1,05 0,55 0°-10° 0,15 0,05 Seating Plane - 2,00 MAX $|\Box|0,10$ PINS ** 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G**)

14-PINS SHOWN

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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